GOVERNMENT OF ANDHRA PRADESH
ABSTRACT

IT, E&C Dept - Promotions Wing – Approval for allotment of 20 acres land to CIPSA TEC India Pvt Ltd, for establishing PCB manufacturing plant in Naidupeta, Tirupati District, and for consideration of the project under AP Electronics Component Manufacturing Policy 2025-2030, for extending incentives including early bird incentives for a proposed investment of INR 1,140 Crores, with potential to create 1,251 jobs - Orders – Issued.

INFORMATION TECHNOLOGY, ELECTRONICS AND COMMUNICATION [IT,E&C] (PROMOTIONS) DEPARTMENT

G.O.MS.No. 70 Date: 12.12.2025

Read the following

1. Andhra Pradesh Electronics Component Manufacturing Policy (4.0) 2025-30 issued vide G.O.Ms.No.30 Date: 01.08.2025.
2. The proposal of CIPSA TEC India Pvt Ltd
3. File No: APIIC-25/108/2025-PROJSEC-APIIC Dated: 22.11.2025
4. Minutes of State Investment Promotion Committee Meeting Date: 24.11.2025
5. Minutes of State Investment Promotion Board Meeting Date: 04.12.2025

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ORDER:

The Government of Andhra Pradesh is actively pursuing strategic initiatives to position the state as a premier destination for investments in electronics components manufacturing. Recognizing that electronic components constitute a critical segment of the electronics value chain, the government is focused on fostering an ecosystem that supports innovation, scalability, and global competitiveness in this sector. By leveraging its strategic location, skilled workforce, and progressive governance, Andhra Pradesh aims to emerge as a hub for electronics components manufacturing, thereby playing a pivotal role in India's broader vision of becoming a global electronics manufacturing powerhouse.

2. In the reference 1, the Government of Andhra Pradesh issued the Electronics Component Manufacturing Policy (4.0) 2025-30 to capitalize on opportunities in electronic component manufacturing. The policy focuses on establishing the state as a leader in electronic component manufacturing by fostering innovation, attracting investments, creating jobs, and building a robust manufacturing ecosystem.

3. In the reference 2, CIPSA TEC India Pvt Ltd has submitted a proposal to establish “high, medium and proto volume of Hi-Speed RF PCBs, Flexible PCBs and Rigid-Flexi PCBs” manufacturing plant in Naidupeta, Andhra Pradesh, with a proposed investment of INR 1,140 Crores. The project has employment potential of 1,251 jobs. The company has also requested the sanction of incentives under the Andhra Pradesh Electronics Component Manufacturing Policy (4.0), 2025–30.

4. The Andhra Pradesh Economic Development Board (APEDB) confirmed that the proposed activities related to PCB manufacturing fall under the Electronics Components Manufacturing Policy of the Government of Andhra Pradesh. Further, APEDB confirmed that this project is one of the first 10 projects under the policy and will be eligible for the applicable incentives.

5.The Andhra Pradesh Economic Development Board (APEDB) after evaluating the proposal, recommended the proposal to the Consultative Committee on Information Technology and Electronics Industry (CCITEI). The proposal was placed before the CCITEI in its meeting held on 23.11.2025. The CCITEI forwarded the proposal to the SIPC (State Investment Promotion Committee). The SIPC, in its meeting held on 24.11.2025, approved the same to be placed before SIPB.

6.Accordingly, the proposal was placed before the SIPB (State Investment Promotion Board) meeting which was held on 04.12.2025. The SIPB based on the recommendations from SIPC decided as follows:

A. *Allotment of 20 acres of land to M/s CIPSA TEC India Pvt Ltd at Plot Nos 117 to 130 MPSEZ Naidupeta, Tirupati (D) with 75% discount of land price as per Andhra Pradesh Electronics Component Manufacturing Policy (4.0) 2025-30.*

B. *Extending early bird incentives as per Andhra Pradesh Electronics Component Manufacturing Policy (4.0) 2025-30, subject to receipt of approval from MeitY, GoI, under the ECMS scheme.*

7. The Government after careful examination of the proposal and keeping in the view the recommendations of the SIPB, hereby accords approval for the allotment of 20 acres of land at Plot Nos 117 to 130 MPSEZ Naidupeta, Tirupati, to CIPSA TEC India Pvt Ltd, with 75% discount of land price as per Andhra Pradesh Electronics Component Manufacturing Policy (4.0) 2025-30. The project shall be eligible for incentives, including early bird incentives, as per the provisions of the AP Electronic Components Manufacturing Policy (4.0) 2025–30, with the condition that the approval of project from MeitY, GoI, under the Electronic Components Manufacturing Scheme. This land allocation is for establishing high, medium and proto volume of Hi-Speed RF PCBs, Flexible PCBs and Rigid-Flexi PCBs manufacturing facility with an investment of INR 1,140 Crores and employment of 1,251.

8. The MD, APTS and the VC& MD, APIIC, Mangalagiri, shall take necessary action.

(BY ORDER AND IN THE NAME OF THE GOVERNOR OF ANDHRA PRADESH)

BHASKAR KATAMNENI
SECRETARY TO GOVERNMENT

To
CIPSA TEC India Pvt Ltd
The Secretary, Ministry of Electronics & Information Technology (MeitY), GoI.
The Spl. Chief Secretary to Government, Revenue (CT) Department
The Secretary to Govt., Industries and Commerce Dept.
The VC&MD, APIIC Ltd, Mangalagiri.
The Principal Secretary to Government, Finance Department
The Principal Secretary to Government, Energy, I&I Department
The Principal Secretary to Government, MA&UD Dept.
The Director, Industries, Andhra Pradesh
The CEO, Andhra Pradesh Economic Development Board

The District Collector and Magistrate, Tirupati District.
The CMD, APSPDCL, Tirupati.
The MD, APTS, Vijayawada

Copy to:
The OSD to Hon'ble Minister for Information Technology, Andhra Pradesh
The PS to Principal Secretary to Hon'ble Chief Minister
The LET & F (Employment) Department.
The Law (B) Department
The GM, DIC, Tirupati
The ZM, APIIC, Tirupati
The P.S. to Secretary to Government & CIP
The P.S. to Secretary/Special Secretary to Government, IT, E&C Department
SC/SF

// FORWARDED: BY ORDER //

SECTION OFFICER